

## Basic information

2013/2905(DEA)

DEA - Delegated acts procedure

Exemption for lead in solders on printed circuit boards, termination coatings of electrical and electronic components and coatings of printed circuit boards, solders for connecting wires and cables, solders connecting transducers and sensors that are used durably at a temperature below -20°C

Supplementing [2008/0240\(COD\)](#)

### Subject

3.40.06 Electronics, electrotechnical industries, ICT, robotics  
3.70.13 Dangerous substances, toxic and radioactive wastes (storage, transport)

Procedure completed - delegated act enters into force

## Key players

European Parliament

Committee responsible

Rapporteur

Appointed

ENVI

Environment, Public Health and Food Safety

## Key events

Date	Event	Reference	Summary
18/10/2013	Non-legislative basic document published	<a href="#">C(2013)06798</a>	
18/10/2013	Initial period for examining delegated act 2 month(s)		
23/10/2013	Committee referral announced in Parliament		
19/12/2013	Delegated act not objected by Council		
07/01/2014	Delegated act not objected by Parliament		

## Technical information

Procedure reference	2013/2905(DEA)
Procedure type	DEA - Delegated acts procedure
Procedure subtype	Examination of delegated act
Amendments and repeals	Supplementing <a href="#">2008/0240(COD)</a>
Stage reached in procedure	Procedure completed - delegated act enters into force
Committee dossier	ENVI/7/14364

## Documentation gateway

European Commission

Document type	Reference	Date	Summary
Non-legislative basic document	C(2013)06798	18/10/2013	